

**WLCSP51, 2.364x2.325**  
**CASE 567MT**  
**ISSUE B**

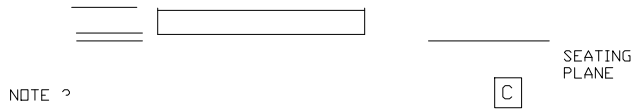
**SCALE 4:1**

**DATE 19 MAY 2023**

1. DIMENSIONING AND TOLERANCING PER ASME

RS

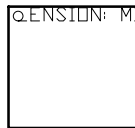
3. COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE SOLDER BALLS.



			MAX.
A	J19		0.381
A1	0.060	0.075	0.090
A2			
A3	0.022	0.025	0.028
b	0.09	0.10	0.12
D	2.?		
E			

**GENERIC MARKING DIAGRAM\***

DIMENSION: MILLIMETER



- XXXXXX = Specific Device Code
- A = Assembly Location
- WL = Wafer Lot
- YY = Year
- WW = Work Week
- = Pb-Free Package